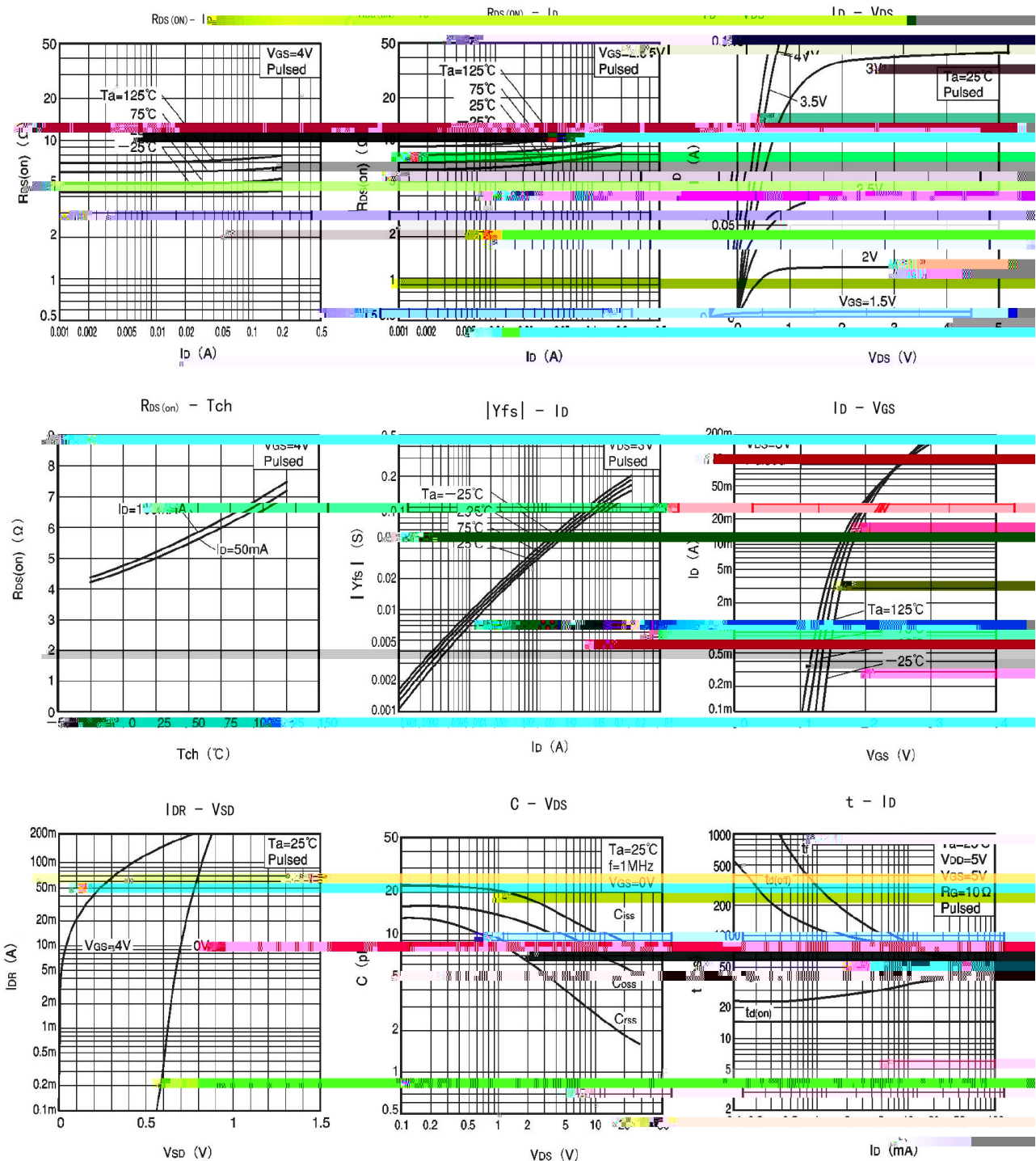
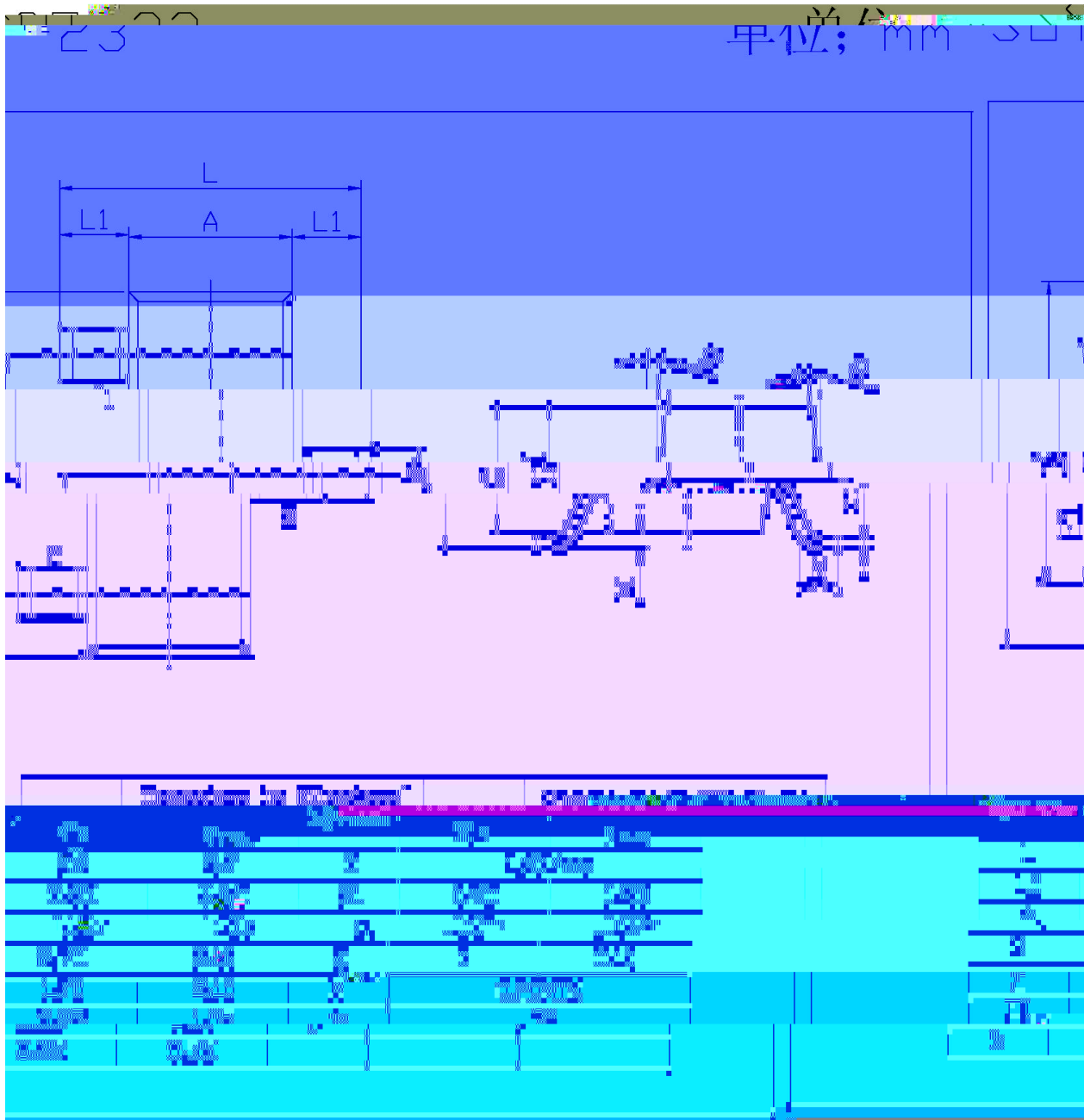


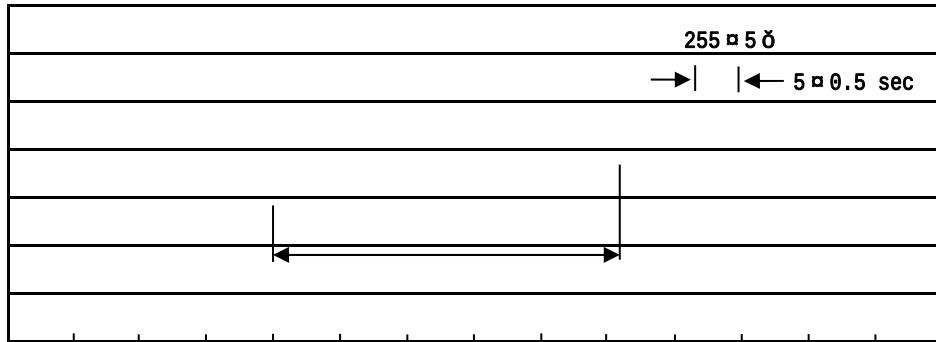
/ Electrical Characteristic Curve



/ Package Dimensions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



- Note:
1. Preheating: 150~200 °C, Time: 60~120sec.
 2. Peak Temp.: 255±5 °C, Duration: 5±0.5sec.
 3. Cooling Speed: 2~10 °C/sec.

/ Resistance to Soldering Heat Test Conditions

Temp.: 260±5 °C Time: 10±1 sec.

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
SOT-23	3,000	10	30,000	6	180,000	7 × 8	180×120×180	390×385×205

/ Notices